# 5557932-1 × OBSOLETE

### **CHAMP**

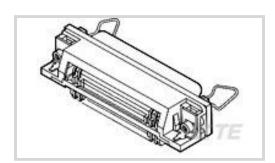
TE Internal #: 5557932-1

TE Internal Description: RCPT ASSY,50POS,SHLD,RTANG D-Sub Shielded Receptacle Assembly: Right Angle, 2.16mm

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Connectors > D-Shaped Connectors > D-Sub Connectors > PCB D-Sub Connectors > D-Sub Shielded Receptacle Assembly: Right Angle, 2.16mm



Connector & Housing Type: Receptacle

Connector System: Cable-to-Board

Number of Positions: 50

Centerline (Pitch): 2.16 mm [ .085 in ]

Number of Rows: 2

All D-Sub Shielded Receptacle Assembly: Right Angle, 2.16mm (20)

## **Features**

## **Product Type Features**

Connector & Housing Type	Receptacle
Connector System	Cable-to-Board
Connector & Contact Terminates To	Printed Circuit Board

## **Configuration Features**

Number of Positions	50
Number of Rows	2
PCB Mount Orientation	Right Angle

## **Body Features**

Shield Plating Finish	Bright
Shield Plating Material	Nickel over Copper
Shield Material	Zinc
Primary Product Color	Black
Connector Profile	Standard

### **Contact Features**

Contact Options	Installed
Contact Mating Area Plating Material Thickness	.76 µm
Contact Mating Area Plating Material	Gold



Operating Temperature Range -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	PCB Contact Termination Area Plating Material	Tin
Termination Features  Rectangular Termination Post & Tail Thickness	Contact Base Material	Copper Alloy
Rectangular Termination Post & Tail Thickness Rectangular Termination Post & Tail Width Termination Method to Printed Circuit Board Through Hole - Solder  Mechanical Attachment  1.28 in  Panel Attachment Style Rear Mount PCB Mount Retention PCB Mount Retention Type Boardlock Mating Retention Type Screwlocks Connector Mounting Type Panel Mount Housing Features  Housing Material Polyester GF Centerline (Pitch) Dimensions  PCB Thickness (Recommended) Row-to-Row Spacing A 3 mm[.169 in]  Usage Conditions  Operating Temperature Range  -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes Circuit Application  Packaging Features	Contact Current Rating (Max)	3.5 A
Rectangular Termination Post & Tail Width .5 mm[,019 in] Termination Method to Printed Circuit Board Through Hole - Solder  Mechanical Attachment  .128 in  Panel Attachment Style Rear Mount  PCB Mount Retention With  PCB Mount Retention Type Boardlock  Mating Retention Type Screwlocks  Connector Mounting Type Panel Mount  Housing Features  Housing Material Polyester CF  Centerline (Pitch) 2.16 mm[,085 in]  Dimensions  PCB Thickness (Recommended) 1.57 mm[,062 in]  Row-to-Row Spacing 4.3 mm[,169 in]  Usage Conditions  Operating Temperature Range -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	Termination Features	
Termination Method to Printed Circuit Board  Mechanical Attachment  .128 in  Panel Attachment Style  PCB Mount Retention  PCB Mount Retention Type  Boardlock  Mating Retention  Mith  Mating Retention Type  Connector Mounting Type  Panel Mount  Housing Features  Housing Material  Centerline (Pitch)  PCB Thickness (Recommended)  Row to Row Spacing  Van to Row Spacing  Operation/Application  Shielded  Yes  Circuit Application  Packaging Features  Through Hole - Solder  Rear Mount  With  Rear Mount  PCB Mount  With  PCB Mount Retention Type  Screwlocks  Connector Mounting Type  Panel Mount  Panel Mount  Polyester GF  2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended)  1.57 mm[.062 in]  Ves  Circuit Application  Signal  Packaging Features	Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Mechanical Attachment  .128 in  Panel Attachment Style Rear Mount  PCB Mount Retention  With  PCB Mount Retention Type Boardlock  Mating Retention  Miting Retention Type  Screwlocks  Connector Mounting Type  Panel Mount  Housing Features  Housing Material  Polyester GF  Centerline (Pitch)  2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  4.3 mm[.169 in]  Usage Conditions  Operation/Application  Shielded  Yes  Circuit Application  Signal  Packaging Features	Rectangular Termination Post & Tail Width	.5 mm[.019 in]
Panel Attachment Style Rear Mount  PCB Mount Retention  PCB Mount Retention Type  Boardlock  Mating Retention  Mith  Mating Retention Type  Screwlocks  Connector Mounting Type  Panel Mount  Housing Features  Housing Material  Polyester GF  Centerline (Pitch)  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  Usage Conditions  Operating Temperature Range  40 – 105 °C[ 40 – 221 °F]  Operation/Application  Shielded  Yes  Circuit Application  Signal  Packaging Features	Termination Method to Printed Circuit Board	Through Hole - Solder
Panel Attachment Style Rear Mount  PCB Mount Retention  PCB Mount Retention Type Boardlock  Mating Retention  Mith  Mating Retention Type Screwlocks  Connector Mounting Type Panel Mount  Housing Features  Housing Material Polyester GF  Centerline (Pitch) 2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended) 1.57 mm[.062 in]  Row-to-Row Spacing 4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range 40 – 105 °C[.40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	Mechanical Attachment	
PCB Mount Retention Type Boardlock  Mating Retention With  Mating Retention Type Screwlocks  Connector Mounting Type Panel Mount  Housing Features  Housing Material Polyester GF  Centerline (Pitch) 2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended) 1.57 mm[.062 in]  Row-to-Row Spacing 4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range -40 – 105 °C[ 40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features		.128 in
PCB Mount Retention Type  Mating Retention  With  Mating Retention Type  Screwlocks  Connector Mounting Type  Panel Mount  Housing Features  Housing Material  Polyester GF  Centerline (Pitch)  2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range  -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded  Yes  Circuit Application  Signal  Packaging Features	Panel Attachment Style	Rear Mount
Mating Retention With  Mating Retention Type Screwlocks  Connector Mounting Type Panel Mount  Housing Features  Housing Material Polyester GF  Centerline (Pitch) 2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended) 1.57 mm[.062 in]  Row-to-Row Spacing 4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	PCB Mount Retention	With
Mating Retention Type  Connector Mounting Type  Panel Mount  Housing Features  Housing Material  Polyester GF  2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  Usage Conditions  Operating Temperature Range  -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded  Yes  Circuit Application  Packaging Features	PCB Mount Retention Type	Boardlock
Connector Mounting Type Panel Mount  Housing Features  Housing Material Polyester GF  Centerline (Pitch) 2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended) 1.57 mm[.062 in]  Row-to-Row Spacing 4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	Mating Retention	With
Housing Features  Housing Material Polyester GF  Centerline (Pitch) 2.16 mm[.085 in]  Dimensions  PCB Thickness (Recommended) 1.57 mm[.062 in]  Row-to-Row Spacing 4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	Mating Retention Type	Screwlocks
Housing Material  Centerline (Pitch)  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  Usage Conditions  Operating Temperature Range  Operation/Application  Shielded  Yes  Circuit Application  Polyester GF  2.16 mm[.085 in]  4.3 mm[.062 in]  4.3 mm[.169 in]  Vad – 105 °C[-40 – 221 °F]  Signal  Packaging Features	Connector Mounting Type	Panel Mount
Centerline (Pitch)  Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  4.3 mm[.062 in]  Usage Conditions  Operating Temperature Range  -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded  Yes  Circuit Application  Signal  Packaging Features	Housing Features	
Dimensions  PCB Thickness (Recommended)  Row-to-Row Spacing  4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range  -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded  Yes  Circuit Application  Signal  Packaging Features	Housing Material	Polyester GF
PCB Thickness (Recommended)  Row-to-Row Spacing  4.3 mm[.169 in]  Usage Conditions  Operating Temperature Range  -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded  Yes  Circuit Application  Signal  Packaging Features	Centerline (Pitch)	2.16 mm[.085 in]
Row-to-Row Spacing  Usage Conditions  Operating Temperature Range  -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded  Yes  Circuit Application  Signal  Packaging Features	Dimensions	
Usage Conditions  Operating Temperature Range -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	PCB Thickness (Recommended)	1.57 mm[.062 in]
Operating Temperature Range -40 – 105 °C[-40 – 221 °F]  Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	Daniela Daniela di Caracia di	13 mm[160 in]
Operation/Application  Shielded Yes  Circuit Application Signal  Packaging Features	Row-to-Row Spacing	4.5 11111[.107 111]
Shielded Yes  Circuit Application Signal  Packaging Features	Usage Conditions	4.5 mm[. 107 m]
Circuit Application Signal  Packaging Features	Usage Conditions	
Packaging Features	Usage Conditions  Operating Temperature Range	
	Usage Conditions  Operating Temperature Range  Operation/Application	-40 – 105 °C[-40 – 221 °F]
	Usage Conditions  Operating Temperature Range  Operation/Application  Shielded	-40 – 105 °C[-40 – 221 °F] Yes
Packaging Quantity 40	Usage Conditions  Operating Temperature Range  Operation/Application  Shielded  Circuit Application	-40 – 105 °C[-40 – 221 °F] Yes
Packaging Method Tray	Usage Conditions  Operating Temperature Range  Operation/Application  Shielded  Circuit Application  Packaging Features	-40 – 105 °C[-40 – 221 °F]  Yes  Signal

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JUN 2016 (169) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

# Customers Also Bought



















## **Documents**

### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_5557932-1\_A.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5557932-1\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5557932-1\_A.3d\_stp.zip

English

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## **Product Specifications**

**Application Specification** 

English